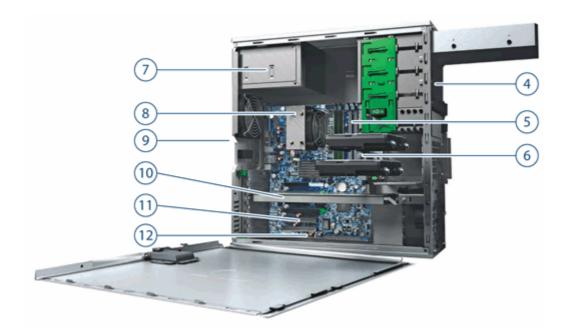
Overview

HP recommends Windows Vista®
Business



- 1. 3 External 5.25" Bays
- 2. Power Button
- 3. Front I/O: 2 USB 2.0, 1 IEEE 1394a (optional card required), Headphone, Microphone

Overview



- 4. 3 External 5.25" Bays
- 5. 4 DIMM Slots for DDR3 ECC Memory
- 6. 2 Internal 3.5" Bays
- 7. 475W, 85% efficient Power Supply
- 8. Dual/Quad Core Intel 3500 Series Processors
- Rear I/O: 6 USB 2.0, PS/2 keyboard/mouse
 RJ-45 to Integrated Gigabit LAN
 Audio Line In, 1 Audio Line Out, 1 Microphone In
- 10. 2 PCle x16 Gen2 Slots
- 11.. 1 PCle x4 Gen2, 1 PCle x4 Gen1, 2 PCl Slots
- 12 4 Internal USB 2.0 ports

E	
Form Factor	Convertible Minitower
Compatible Operating	Genuine Windows Vista® Business 32-bit*
Systems	Genuine Windows Vista® Business 64-bit*
	Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit custom installed** (expected available until August 2009)
	Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64 custom installed** (expected available until August 2009)
	HP Linux Installer Kit for Linux (includes drivers for both 32-bit & 64-bit OS versions of Red Hat Enterprise Linux WS4 and WS5 - see: http://www.hp.com/workstations/software/linux) Novell Suse SLED 11 (expected availability May 2009)
	*Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.
	**Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.
Available Processors	Intel® Xeon® Processor W3503 2.40 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core Intel Xeon Processor W3505 2.53 GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core

Overview	
	Intel Xeon Processor W3520 2.66 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT, Turbo Intel Xeon Processor W3540 2.93 GHz, 8MB cache, 1066 memory, 4.8 GT/s QPI, Quad-Core, HT, Turbo Intel Xeon Processor W3570 3.20 GHz, 8MB cache, 1333 memory, 6.4 GT/s QPI, Quad-Core, HT, Turbo
Available Processor Disclaimers	Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor_number/ for details.
	64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t fo more information.
	Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.
	Intel's numbering is not a measurement of higher performance.
Color	Jack Black/Alloy metallic
Convertibility	Yes. 5.25" drives rotate for Minitower or Desktop orientation.
Expansion Slots (see system board section for more details)	 2 PCI slots (full-height, full-length) 1 PCI Express Gen2 slot x8 mechanical/x4 electrical 1 PCI Express Gen1 slot x8 mechanical/x4 electrical 2 PCI Express x16 Gen2 slots (one dedicated for graphics)
Expansion Bays (see storage section for more details)	 2 internal 3.5" bays 3 external 5.25" bays NOTE: Third external 5.25" bay is not full depth; maximum depth 170 mm (6.7 inches)
Front I/O	2 USB 2.0, 1 IEEE 1394 (requires optional PCI card to function), 1 audio out, and 1 microphone.
Rear I/O	6 USB 2.0, 1 optional serial port, 2 PS/2, RJ-45 (NIC), 1 audio line in, 1 audio line out, 1 microphone in; audio ports can be retasked to function as line in, line out, microphone, or headphone.
Interfaces Supported	22-in-1 Media Card Reader (optional)
Chassis Dimensions (W x	Standard minitower orientation: 6.6 x 17.9 x 17.7 in (16.79 x 45.53 x 45.02 cm)
D x H)	Converted desktop orientation: 6.6 x 17.9 x 17.7 in (16.79 x 45.53 x 45.02 cm)
Weight	Exact weights depend upon configuration Minimum: 29.8 lbs (13.5 kg) Standard: 33.2 lbs (15.1 kg) Maximum: 43.2 lbs (19.6 kg)
Temperature	Operating: 40° to 95°F (5° to 35°C) Non-operating -40° to 140° F (-40° to 60° C)
Humidity	Operating: 8% to 85% Non-operating 8% to 90%
Maximum Altitude (non-	Operating: 10,000 feet; 3,000 m
pressurized)	Non-operating 30,000 feet; 9,100 m
Power Supply	475 watts wide-ranging, active Power Factor Correction, 85% Efficient



Supported Components

Processors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Quad-Core Intel® Xeon® Processor 3500 Series with Int	el® 64 Archit	ecture		
	Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Υ	Ν		
	Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core	Υ	Ν		
	Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Υ	Ν		
	Intel Xeon W3540, 2.93GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo	Υ	Ν		
	Intel Xeon W3570, 3.20GHz, 8MB cache, 1333 memory, 6.4GT/s, Quad-Core, HT, Turbo	Υ	Ν		

When ordering two processors, the second processor must be the same as the first. Intel processor numbers are not a measurement of higher performance. Processor numbers differentiate features within each processor family, not across different processor families. See: http://www.intel.com/products/processor number/ for details.

Dual-Core and Quad-Core technologies are designed to improve performance of multithreaded software products and hardware-aware multitasking operating systems and may require appropriate operating system software for full benefits; check with software provider to determine suitability; Not all customers or software applications will necessarily benefit from use of these technologies.

64-bit computing on Intel® 64 architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers and applications enabled for Intel 64 architecture. Processor will not operate (including 32-bit operation) without an Intel 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. See: http://www.intel.com/info/em64t for more information.

Intel's numbering is not a measurement of higher performance.



Supported Components

Sub-Section Description/Notes

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

ς	AS	Нα	rd	Driv	/AC
. 1	М.)	1 1(1		יוולו	v >

or system disk is reserved for system recevery sometime (visit	٠,٠			
	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP SAS (Serial Attached SCSI) Hard Drives for HP Worksto	ations			
146 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	EA330AA	
300 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	EM174AA	
450 GB 15K rpm SAS 3.0 Gb/s 3.5" Hard Drive	Υ	Υ	FM803AA	
Sub-Section Description/Notes				
Up to (4) 3.5-inch 7200 rpm SATA drives:160, 250, 320, Up to (4) 2.5-inch 10K rpm SATA drives:160, 300 GB 1.2 Up to (4) 3.5-inch 15K rpm SAS devices: 146, 300, 450, 6	TB max	•	6.0 TB max	
Removable Boot Drive option				
SATA (Serial ATA) Hard Drives for HP Workstations				
160 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Y	PV944A	
250GB SATA 7200 rpm 3Gb/s 3.5" HDD (for HP Z-Workstations)	Y	Υ	PY278AA	
220 CP 7 200 rom SATA 2.0 Ch/o with NICO 2.5" Hard	V	V	EH043 V V	

SATA Hard Drives

· · · · · (• · · · · · · · · · · · · · ·				
160 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	PV944A	
250GB SATA 7200 rpm 3Gb/s 3.5" HDD (for HP Z-Workstations)	Υ	Υ	PY278AA	
320 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	FH963AA	
500 GB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	PV943A	
1 TB 7,200 rpm SATA 3.0 Gb/s with NCQ 3.5" Hard Drive	Υ	Υ	GE262AA	
160 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Υ	Υ	EW222AA	
300 GB 10K rpm SATA with NCQ 2.5" Hard Drive	Υ	Υ	FM802AA	
NOTE CAC Controlled and the control to the M				

NOTE: SAS Controller, not integrated, is required)

For hard drives, 1 GB = 1 billion bytes; TB = 1 trillion bytes. Actual formatted capacity is less. Up to 12 GB of hard drive (or system disk) is reserved for the system recovery software (XP and XP Pro). Up to 3 GB of system disk is reserved for system recovery software (Vista).

Supported Components

Hard Drive Controllers		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Integrated SATA 3.0 Gb/s Controller				
	Integrated SATA 3.0 Gb/s	Υ	Ν		
	Factory integrated RAID on motherboard for SATA	drives			
	RAID 0 Configuration - Striped Array	Υ	Ν		See note 1
	RAID 0 Data Configuration Boot/OS Drive + 2 Drive Striped Array	Y	Ν		See note 1
	RAID 1 Configuration - Mirrored Array	Υ	Ν		See note 1
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card				
	LSI 3041E 4-Port SAS 3.0 Gb/s RAID Card	Υ	Υ	EH417AA	See note 2 and 3
	LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA)			
	LSI 8888ELP 8-port SAS HW RAID Card	Ν	Υ	GE258AA	

SATA hardware RAID is not supported on Linux systems. The Linux kernel, with built-in software RAID, provides excellent functionality and performance. It is a good alternative to hardware-based RAID. Please visit http://h20000.www2.hp.com/bc/docs/support/SupportManual/c00060684/c00060684.pdf for RAID capabilities with Linux.

All drives must be identical in type and capacity

All RAID arrays must be less than 2 TB

NOTE 1: Requires identical hard drives (speeds, capacity, interface. Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit:

http://www.hp.com/support/linux hardware matrix for details.

NOTE 2: Specific user-configured hardware SAS RAID configurations are supported on this Linux system. Please visit: http://www.hp.com/support/linux hardware matrix for details.

NOTE 3: Not supported when HD drive 1 is SATA

Graphics		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	Supported Multi Mixed
	Professional 2D					
	NVIDIA Quadro NVS 450 512 MB PCle Graphics Card	Υ	Y	FH519AA	2nd card must be NVS 295	1
	NVIDIA Quadro NVS 295 256MB PCle Graphics Card	Υ	Y	FY943AA	2nd card must be NVS 295	2
	NVIDIA Quadro NVS 290 256 MB PCle Graphics Card with 'DMS-59 to Dual DVI cable' included - for Workstations	Ν	Y	GN502AA	1 or 2 of these cards are supported - 2nd card must be NVS 290 or NVS 440	2
	Entry 3D					
	NVIDIA Quadro FX 380 256MB PCIe Graphics Card	Υ	Y	NB769AA		2
	ATI FirePro V3700 256MB PCle Graphics Card	Υ	Υ	FY944AA		2



NVIDIA Quadro FX 580 512MB PCIe Graphics Card	Υ	Υ	FY945AA	2
Mid-range 3D				
NVIDIA Quadro FX 1800 768MB PCle Graphics Card	Υ	Y	FY946AA	2
ATI FirePro V5700 512MB PCle Graphics Card	Υ	Y	FY947AA	2
High End 3D				
NVIDIA Quadro FX 3800 1.0GB PCle Graphics Card (AVAILABLE JUNE 2009)	Υ	Y	FY949AA	1
ATI FirePro V7750 1.0GB PCle Graphics Card	Υ	Υ	FY948AA	1
NVIDIA Quadro FX 4800 1.5GB PCle Graphics Card	Υ	Υ	FQ138AA	1
NVIDIA Quadro CX - The Accelerator for Creative Suite 4	Υ	Ν		1

Memory CTO Support Notes

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs CTO

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

2GB (2x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

000 (0.100) 0000 1000 500 11 1 (1...1044.1.001

3GB (3x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

4GB (4x1GB) DDR3-1333 ECC Unbuffered RAM 1-CPU 4GB (2x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

6GB (3x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

8GB (2x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

8GB (4x2GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

12GB (3x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

16GB (4x4GB) DDR3-1333 ECC Unbuffered RAM 1-CPU

Sub-Section Description/Notes

NOTE: Configurations less than 1 GB are not supported on Windows Vista 64 or Vista 64 downgrade to XP 64. DIMMs should be distributed across all three memory channels for optimal performance. Each processor supports up to 3 channels of DDR3 memory. To realize full performance at least 1 DIMM must be inserted into each channel.

AMO

PC3-10600 DDR3-1333 ECC Unbuffered DIMMs AMO

1GB (1x1GB) DDR3-1333 ECC Unbuffered RAM

2GB (1x2GB) DDR3-1333 ECC Unbuffered RAM

4GB (1x4GB) DDR3-1333 ECC Unbuffered RAM

NOTE: Only unbuffered DDR3 DIMMs are supported.



Supported Components

Multimedia and Audio Devices		Factory Configured	Option Kit	Option Kit Part Number	Support Notes	
	Integrated Intel/Realtek HD ALC262 Audio	Υ	Ν			
	HP Thin USB Powered Speakers	Υ	Υ	KK912AA		
	Creative X-Fi Titanium PCle Audio Card	Υ	Υ	NH222AA		

Optical and Removable Storage		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP 16X DVD-ROM SATA Drive	Υ	Υ	AR629AA	See note 1
	HP 16X DVD+-RW SuperMulti SATA Drive	Υ	Υ	AR630AA	
	HP Blu-ray Writer	Υ	Υ	AR482AA	
	1.44 MB Diskette Drive (1 only)	Υ	Υ	NK360AA	
	HP 22-in-1 Media Card Reader Kit (Workstations)	Υ	Υ	NK361AA	

Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players. As Blu-ray is a new format containing new technologies, certain disc, digital connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support. HD-DVD movies cannot be played on this workstation.

NOTE 1: Not supported as a 2nd drive option.

Controller Cards		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP FireWire/IEEE 1394a PCI Card	Υ	Υ	PA997A	
	HP IEEE 1394b FireWire PCle Card	Υ	Υ	NK653AA	
Monitors		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP LP1965 19-inch LCD Monitor	Υ	Υ	RA373A	
	HP LP2275w 22-inch Widescreen LCD Monitor	Υ	Υ	KE289A	
	HP LP2475w 24-inch Widescreen LCD Monitor	Υ	Υ	KD911A	
	HP DreamColor LP2480zx Professional Display	Υ	Υ	GV546A	
	HP LP3065 30-inch Widescreen LCD Monitor	Υ	Υ	EZ320A	
	NOTE: Supported by all Operating Systems available	from HP (screen size	ze diagon	ally measure	ed)

Supported Components

Networking and		_		Option Kit	
Communications		Factory Configured	Option Kit	Part Number	Support Notes
	Integrated Broadcom 5764 PCIe LOM Controller	Υ	Ν		
	Broadcom NetXtreme Gigabit Ethernet Plus NIC (PCle)	Y	Y	FS215AA	This is a PCI Express card based on the Broadcom 5761 chip.
	Intel Gigabit CT Desktop NIC	Ν	Υ	FH969AA	

NOTE 1: Certain Windows Vista product features require advanced or additional hardware. See http://www.microsoft.com/windowsvista/getready/hardwarereqs.mspx and http://www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit http://www.windowsvista.com/upgradeadvisor.

"Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Racking and Physical Security		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	Security Cable with Kensington Lock	Ν	Υ	PC766A	
	HP Solenoid Hood Lock & Hood Sensor				
	HP (CMT) Solenoid Lock	Ν	Υ	DE618A	
	HP xw4/Z4 Depth Adjustable Fixed Rail Rack Kit	Ν	Υ	EK729AA	
Input Devices				Option Kit	

vices	Factory Configured	Option Kit	Option Kit Part Number	Support Notes
HP PS/2 Standard Keyboard	Υ	Υ	DT527A	
HP USB Standard Keyboard	Υ	Υ	DT528A	
HP PS/2 Optical Scroll Mouse	Υ	Υ	EY703AA	
HP USB 2-Button Optical Scroll Mouse	Υ	Υ	DC172B	
HP USB Laser Mouse	Υ	Υ	GW405AA	
HP USB Optical 3-Button Mouse	Υ	Υ	DY651A	
HP USB Smart Card Keyboard	Ν	Υ	ED707AA	
HP 2.4GHz Wireless Keyboard & Mouse	Ν	Υ	NB896AA	
HP USB Optical 3-Button 2.9M OEM Mouse	Ν	Υ	ET424AA	
HP SpaceExplorer 3D USB Controller	Ν	Υ	RY429AA	
HP SpacePilot 3D USB Intelligent Controller	Ν	Υ	EF390AA	



Supported Components

Other Hardware				Option Kit	
		Factory Configured	Option Kit	Part Number	Support Notes
	Configure minitower in desktop orientation	Υ	Ν		
	HP ENERGY STAR 5.0 Enabled Configuration	Υ	Ν		
	HP Workstation Mouse Pad	Y	Ν		Japan only.
	HP eSATA PCI Cable Kit	Υ	Υ	GM110AA	
	HP Power Cord Kit	Ν	Υ	DM293A	
	HP 2nd Serial Port Adapter	Ν	Υ	PA716A	
	HP Internal USB Port Kit	Ν	Υ	EM165AA	
	HP Optical Bay HDD Mounting Bracket	Ν	Υ	NQ099AA	
	HP Workstation to LTO SAS Int. Cable	Ν	Υ	EH925A	
	HP Fan and Front Card Guide Kit	Ν	Υ	DY648A	

Software		Factory Configured	Option Kit	Option Kit Part Number	Support Notes
	HP Performance Tuning Framework	Υ	Ν		
	Roxio Easy Media Creator (CD or DVD burner)	Υ	Ν		
	Intervideo WinDVD with DVD player	Υ	Ν		
	HP Backup and Recovery	Y	Ν		Supported on Windows XP ONLY
	PDF Complete	Υ	Ν		
	Microsoft Office 2007 Small Business Edition	Υ	Ν		
	Microsoft Office 2007 Trial Edition	Υ	Ν		
	HP Client Manager Software v6.2 (optional download)	Υ	Ν		
	HP ProtectTools Security	Y	N		Must select as a Configure to Order Option. Delivered as a "Drop in the Box" CD

Supported Components

Operating Systems

Support Notes

Genuine Windows Vista® Business 32-bit

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwareregs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Genuine Windows Vista® Business 64-bit

Certain Windows Vista product features require advanced or additional hardware. See

www.microsoft.com/windowsvista/getready/hardwareregs.mspx and www.microsoft.com/windowsvista/getready/capable.mspx for details. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit www.windowsvista.com/upgradeadvisor.

Genuine Windows Vista® Business 32-bit with downgrade to Windows® XP Professional 32-bit custom installed

Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

Genuine Windows Vista® Business 64-bit with downgrade to Windows® XP Professional x64 custom installed

Windows Vista Business disk may also be included for future upgrade if desired. To qualify for this downgrade an end user must be a business (including governmental or educational institutions) and is expected to order at least 25 customer systems with the same custom image.

HP Linux Installer Kit

see: http://www.hp.com/workstations/software/linux



System Board								
	ATX 9.6 x 12 inches (243.84 x	304.8 n	nm)					
Processor Socket	Single LGA1366	gle LGA1366						
CPU Bus Speed	QPI: Up to 6.4GT/sec							
Chipset	Intel® X58 Express							
Super I/O Controller	SMSC SCH5327, Rev B							
Memory Expansion Slots	4 DDR3 memory slots							
Memory Type Supported	DDR3, UDIMM (Unbuffered), I	ECC						
Memory Modes	Channel Interleaved							
Memory Speed Supported	800MHz, 1066MHz and 1333	3MHz DE	DR3					
Memory Protection	ECC available on data, parity	on addre	ess and c	command	d l			
Memory								
,	NOTE: * Maximum memory of Vista Business 64, XP Professio 32 and XP Professional (32-bit	nal x64 l	Edition, F	Red Hat L	Linux 64-	bit. Gen	uine Windows Vista Business	
					PUD]	
		Capacity 1GB	DIMM1 1GB	DIMM2	DEMENS	DIMM4	-	
		2GB	1CB	108				
		3 C2B 4 C2B	1GB 1GB	1GB 1GB	1GB 1GB	108]	
		4GB	2GB	2GB	108	IGB	1	
		6GB	2GB	2GB	2 GB]	
		#CB	2GB 4GB	2GB 4GB	2 CB	208	-	
		12GB	4CB	4CB	4CB		1	
	l	16GB	4GB	4GB	4CB	4CB]	
Memory Configuration (Supported)	 The 4GB DIMM for Z4C Z800. They are NOT interchar Only ECC DIMMs are s 	ngeable.		OT comp	patible w	ith the 40	GB DIMMs offered on the	
PCI Express Connectors (Gen2 Rev 0.7 connectors)	1 x8 PCle (x4)							
PCI Connectors (5.0V)	2 PCI							
Interfaces Supported	SATA		1, 5,		NCQ. (F		Gb/sec controller with RAID 0, tegrated RAID is Microsoft	
	Hardware RAID is not supporte excellent functionality and perf http://h20000.www2.hp.com/ capabilities with Linux.	formance	. It is a g	good alte	ernative to	o hardwa		
Integrated RAID	NOTE: Requires identical hard	drives (s	peeds, c	capacity,	interface	;)		
Integrated Graphics	No							
Network Controller	Integrated HP Gbit LAN by Bro	 padcom						



system rechnical spe -	-							
IDE connector	No							
Floppy connector	Yes							
Network Controller	Management capabilities WOL, PXE 2.1	Management capabilities WOL, PXE 2.1 and ASF 2.0						
Serial	1 internal header (requires optional Seria	l Port Adaptor)						
2nd Serial	No							
Parallel	No							
Audio	High Definition Integrated Realtek ALC26	2 Audio with Line in, Line Out, Microphone, Headphone						
CD-ROM input/Audio	No							
AUX INPUT; Audio	Yes							
IEEE 1394 Connector(s)	Front	1 IEEE 1394a (requires optional PCI card to function)						
	Rear	No						
	Internal	No						
USB Connector(s)	Front	2 USB 2.0						
	Rear	6 USB 2.0						
	Internal	2 USB 2.0 headers						
HD Integrated Audio	High Definition Integrated Realtek ALC26	2 Audio with Line in, Line Out, Microphone, Headphone						
Flash ROM	Yes	·						
Clear Fan Header	No							
CPU Fan Header	Yes							
Chasiss Fan Header	1 Rear System Chassis Fan Header, 1 Op	I Rear System Chassis Fan Header, 1 Optional Front Chassis Fan Header						
Front PCI Fan Header	Yes							
Front Control Panel/Speaker Header	Yes							
CMOS Battery Holder - Lithium	Yes							
Integrated Trusted Platform Module	Integrated TPM 1.2							
Power Supply Headers	Yes							
Power Switch, Power LED & Hard Drive LED Header	Yes							
Clear Password Jumper	Yes							
Serial Port	1 internal header (requires optional Seria	l Port Adaptor)						
Parallel Port	No							
Keyboard/Mouse	USB or PS/2							
Power Supply	475w 80+ BRONZE, Custom							
Operating Voltage Range								
Rated Voltage Range	118V							
Rated Line Frequency	400 Hz							
Operating Line Frequency Range	393-407 Hz							
Rated Input Current	10A @ 118 VAC							
Heat Dissipation	Maximum 2027 btu/hr (511 kg-cal/hr)							
	,							



· · · · · · · · · · · · · · · · · · ·					
Power Supply Fan	92x25 mm variable speed				
ENERGY STAR® qualified	Yes				
(Config Dependent)					
80 PLUS Compliant	Yes, Bronze				
FEMP Standby Power	Yes				
Compliant 115V (Wake-					
on LAN disabled) (<2W in S5 - Power Off)					
Power consumption in	<5W				
sleep mode (as defined by ENERGY STAR) - Suspend to RAM (S3)					
Built-in Self Test (BIST) LED	Yes				
Surge Tolerant Full	Yes				
Ranging Power Supply					
(withstands power surges up to 2000V)					
Hood Lock Header	Yes				
Hood Sensor Header	Yes				
ASF 2.0 (Alert Standard Format)	Yes				
Z400 Required Power Sup	ply Info				
Power Supply		475 watt custom power supply	- (Wide Ranging Active PFC)		
Operating Voltage Range		90 - 269 VAC			
Rated Voltage Range		100 - 240 VAC	118 VAC		
Rated Line Frequency		50-60 Hz	400 Hz		
Operating Line Frequency	Range	47 - 66 Hz	393 - 407 Hz		
Rated Input Current		10 A @ 110-127 VAC 6 A @ 200-240 VAC	10 A @118 VAC		
Heat Dissipation (Configuration dependent)	ration and software	Typical 954 btu/hr Maximum 1977 btu/l			
Power Supply Fan		92x25 mm va	riable speed		
Energy Star Compliant (co	nfig dependent)	YE	S		
80 PLUS® Compliant		Yes, Bı	onze		
FEMP Standby Power Compliant@115V (Wake-on		YES			
LAN disabled)(<2W in S5					
	Power Off)	YE			
LAN disabled)(<2W in \$5	Power Off) 1 W in S5-Power Off) ep mode (as defined by to RAM (S3) (Instantly		S		
LAN disabled)(<2W in S5- EuP Compliant@230V (< Power Consumption in sle ENERGY STAR) - Suspend	Power Off) 1 W in S5-Power Off) ep mode (as defined by to RAM (S3) (Instantly	YE	S W		
LAN disabled)(<2W in S5 EuP Compliant@230V (< Power Consumption in sle ENERGY STAR) - Suspend Available PC) measured a	Power Off) 1 W in S5-Power Off) ep mode (as defined by to RAM (S3) (Instantly to 115V.	YE <6	S W		
LAN disabled)(<2W in S5- EuP Compliant@230V (< Power Consumption in sle ENERGY STAR) - Suspend Available PC) measured a Built-in Selft Test LED Surge Tolerant Full Rangin	Power Off) 1 W in S5-Power Off) ep mode (as defined by to RAM (S3) (Instantly to 115V.	YE YE	S W S S		



System Technical Specifications

System Configuration

Example
Configuration #1

Processor Info 1x Intel Xeon W3503
Memory Info 1x1GB DDR3 1333 (UDIMM)

Graphics Info NVS295

Disks/Optical/Floppy 1x160GB SATA / 1 Optical / 0 Floppy

PSU 475W 80 PLUS® BRONZE

Energy Consumption

	115 VAC 230 VAC 100		115 VAC		230 VAC		100	VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled		
Windows Idle (S0)	86.2	23 W	85.2	26 W	85.9	90 W		
Windows Busy Typ (SO)	140.	140.90 W		137.85 W		40 W		
Windows Busy Max (S0)	153.20 W		152.96 W		155.	00 W		
Sleep (S3)	4.17 W	3.96 W	4.03 W	3.79 W	4.14 W	3.90W		
Off (S5)	1.25 W	1.14 W	1.51 W	1.35 W	1.23 W	1.12 W		
Zero Power Mode (EuP)	0.31 W		0.61 W		0.2	9W		

Heat Dissipation**

	115	115 VAC		230 VAC		VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	294.30	btu/hr	290.99	btu/hr	293.18	btu/hr
Windows Busy Typ(SO)	480.89	btu/hr	470.48	btu/hr	479.19	btu/hr
Windows Busy Max (SO)	522	.87 btu/hr	522,05	btu/hr	529,02	btu/hr
Sleep (S3)	14.2 btu/hr	13.5 btu/h	13.8 btu/hr	12.9 btu/h	14.1 btu/hr	13.3 btu/hr
Off (\$5)	4.27 btu/hr	3.89 btu/h	5.15 btu/hr	4.61 btu/h	4.20 btu/hr	3.82 btu/hr
Zero Power Mode (EuP)	1,041	otu/hr	2.06 k	otu/hr	0.98 l	otu/hr

System Technical Specifications

Example
Configuration #2

Processor Info 1 x Intel Xeon W3570

Memory Info 4x4GB DDR3 1333MHz (UDIMM)

Graphics Info 1xFX4800

Disks/Optical/Floppy 4x450GB SAS / 1 Optical / 0 Floppy

PSU 475W 80 PLUS® BRONZE

Energy Consumption

	115 VAC		230 VAC		100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	180.	180.70 W		178.30 W		00 W
Windows Busy Typ (SO)	404.60 W		393.20 W		407.	50 W
Windows Busy Max (S0)	482.80 W		469.10 W		488.	60 W
Sleep (S3)	4.84 W	4.65 W	5.13 W	4.94 W	4.85 W	4.66 W
Off (\$5)	1.18 W	1.07 W	1.61 W	1.37 W	1.16 W	1.05W
Zero Power Mode (EuP)	0.32 W		0.61 W		0.2	9 W

Heat Dissipation**

	115	115 VAC		VAC	100 VAC		
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	616.73	btu/hr	608.54	btu/hr	617.75	btu/hr	
Windows Busy Typ(SO)	1380.90	1380.90 btu/hr		1341.99 btu/hr		1390.80 btu/hr	
Windows Busy Max (S0)	1647.80 btu/hr		1601.04	1 btu/hr	1667.59	btu/hr	
Sleep (\$3)	16.5 btu/hr	15.9 btu/hr	17.5 btu/hr	16.9 btu/hr	16.6 btu/hr	15.9 btu/hr	
Off (S5)	4.03 btu/hr	3.65 btu/hr	5.49 btu/hr	4.68 btu/hr	3.96 btu/hr	3.58 btu/hr	
Zero Power Mode (EuP)	1,081	otu/hr	2.06 k	otu/hr	0.98 k	otu/hr	

System Technical Specifications

Example
Configuration #3

Processor Info 1 x Intel Xeon W3520

Memory Info 3x1GB DDR3 1333MHz (UDIMM)

Graphics Info 1xFX1800

Disks/Optical/Floppy 1x250GB SATA / 1 Optical / 0 Floppy

PSU 475W 80 PLUS® BRONZE

Energy Consumption

	115	VAC.	230	VAC:	100	VAC:	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	
Windows Idle (S0)	96.7	70 W	95.1	0 W	97.7	97.71 W	
Windows Busy Typ(SO)	237.99 W		233.	03 W	239.04 W		
Windows Busy Max (SO)	268.79 W		267.95 W		274.90 W		
Sleep (S3)	3.89 W	3.65 W	4.20 W	3.96 W	3.83 W	3.61 W	
Off (\$5)	1.20 W	1.06 W	1.51 W	1.35 W	1.17 W	1.02 W	
Zero Power Mode (EuP)	0.31 W		0,6	0 W	0.2	9 W	

Heat Dissipation**

	115 VAC		230	VAC	100 VAC	
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
Windows Idle (S0)	330.04	btu/hr	324.58	btu/hr	333.48	btu/hr
Windows Busy Typ (SO)	812.26 btu/hr		795.33 btu/hr		815.84 btu/hr	
Windows Busy Max (S0)	917.38	btu/hr	914.51	btu/hr	938.23	btu/hr
Sleep (S3)	13.3 btu/hr	12.5 btu/hr	14.3 btu/hr	13.5 btu/hr	13.1 btu/hr	12.3 btu/hr
Off (S5)	4.10 btu/hr	3.60 btu/hr	5.15 btu/hr	4.61 btu/hr	3.99 btu/hr	3.48 btu/hr
Zero Power Mode (EuP)	1.05 btu/hr		2.05	otu/hr	0.97 k	otu/hr

System Technical Specifications

Example Configuration #4 (Energy Star Compliant) Processor Info 1x Intel Xeon W3570

Memory Info 4x2GB DDR3 1333MHz (UDIMM)

Graphics Info 1 x FX4800

Disks/Optical/Floppy 2x1000GB SATA / 1 Optical / 1 Floppy I/O 1xBroadcom 5761 Gigabit PCIe NIC

PSU 475W 80PLUS® BRONZE

Energy Consumption

	115 VAC		230	VAC	100	VAC
	LAN Enabled	LAN Disabled	L'AN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR [®] Idle (S0))	99.	8 W	97.	7 W	100	.3 W
ENERGY STAR [®] P _{MAX} Windows running Linpack and Viewperf	323.1 W		316	.6 W	325	.4 W
ENERGY STAR® "Sleep" (S3)	4.6 W	-	4.8 W	-	4.6 W	<u>-</u> .
ENERGY STAR ⁸ "Standby" (Off) (S5)	1.8 W	-	2.1 W	-	1.7 W	-

Heat Dissipation**

	115 VAC		230 \	230 VAC		VAC
	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled	LAN Enabled	LAN Disabled
On-Idle (ENERGY STAR ⁵ Idle (S0))	340.6	otu/hr	333,5	otu/hr	342.3	btu/hr
ENERGY STAR® PMAX Windows running Linpack and Viewperf	1102.7 btu/hr		1080.6	btu/hr	1110.6	btu/hr
ENERGY STAR® "Sleep" (S3)	15.7 btu/hr	-	16.4 <u>btu</u> /hr	-	15.7 btu/hr	-
ENERGY STAR [®] "Standby" (Off) (S5)	1.8 btu/hr	-	2.1 btu/hr	-	1.7 btu/hr	-

NOTES:

This product is in compliance with US executive order 13221, WOL (wake on LAN) disabled.

Declared Noise Emissions (Entry-level and High-end configurations)				
System Configuration	Processor Info	Intel Xeon Processor W3505 2.53 GHz		
(Entry level)	Memory Info	4 x 1GB DDR3 1333 MHz		
	Graphics Info	NVIDIA Quadro NVS 295		
	Disks/Optical/Floppy	1 x 160 GB 7200 RPM SATA / DVD-ROM / No Floppy		

^{*} Energy Star low energy mode

^{**} Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	3.9 Bels	23 dB
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	4.2 Bels	25 dB
	Floppy Drive Operating (continuous copy)	4.7 Bels	29 dB
	DVD-ROM Operating (sequential reads)	5.1 Bels	38 dB

- <i> </i> - J	Processor Info	Intel Xeon Processor W3570 3.20 GHz
(High-end)	Memory Info 4 x 1GB DDR3 1333 MHz	
	Graphics Info	NVIDIA Quadro FX 4600
	Disks/Optical/Floppy	2 x 450 GB 15K SAS / DVD-ROM / No Floppy

Declared Noise Emissions		Sound Power (LWAd, bels)	Deskside Sound Pressure
(in accordance with ISO	Idle	4.6 Bels	27 dB
7779 and ISO 9296)	SATA Hard drive Operating (random reads)	5.2 Bels	35 dB
	Floppy Drive Operating (continuous copy)	5.0 Bels	32 dB
	DVD-ROM Operating (sequential reads)	5.3 Bels	38 dB

Environmental Requirements	Temperature	Operating: 40° to 95° F (5° to 35° C) Non-operating: -40° to 140° F (-40° to 60° C)
	Humidity	Operating: 8% to 85% RH, non-condensing Non-operating: 8% to 90% RH, non-condensing
	Maximum Altitude	Operating: 10,000 feet (3,000 m) Non-operating: 30,000 feet (9,100 m)
	Dynamic (new)	Shock Operating: ½-sine: 40g, 2-3ms Non-operating: ½-sine: 160 cm/s, 2-3ms (~100g) square: 422 cm/s, 20g NOTE: Values represent individual shock events and do not indicate repetitive shock events. Vibration Operating random: 0.5g (rms), 5-300 Hz Non-operating random: 2.0g (rms), 10-500 Hz NOTE: Values do not indicate continuous vibration.
	Cooling	Above 5000 ft (1524 m) altitude, maximum operating temperature is derated by 1.8° F (1° C) per 1000 ft (305 m) elevation increase



Physical Security an	nd Serviceability
Access Panel	Tool-less Includes system board and memory information
Optical Drive	Tool-less
Floppy Drive	Tool-less
Hard Drives	Tool-less
Expansion Cards	Tool-less
Processor Socket	Tool-less
Green User Touch Points	Yes, on tool-free internal chassis components
Color-coordinated Cables and Connectors	Yes
Memory	Tool-less
System Board	Tool-less
Dual Color Power and HD LED on Front of Computer	Yes
Configuration Record SW	Yes
Over-Temp Warning on Screen	Yes
Restore CD Set	Restores the computer to its original factory shipping image - Can be obtained via HP Support
Dual Function Front Power Switch	Yes, causes a fail-safe power off when held for 4 seconds
Padlock Support	Yes (optional): Locks side cover and secures chassis from theft 0.22-in diameter padlock loop at rear of system
Cable Lock Support	Yes, Kensington Cable Lock (optional): Locks side cover and secures chassis from theft 3 mm x 7 mm slot at rear of system
Universal Chassis Clamp Lock Support	Yes (optional): Locks side cover and locks cables to chassis. Secures chassis from theft and allows multiple units to be chained together when used with optional cable Threaded feature at rear of system
Solenoid Lock and Hood Sensor	Yes (optional) The Solenoid Hood Lock eliminates the need for a physical key by making the chassis lockable through software and a password. You can also lock and unlock the chassis remotely over the network. The Sensor Kit detects when the access panel has been removed
Rear Port Control Cover	Yes, locks rear IO cables to prevent cable theft
Serial, Parallel, USB, Audio, Network, Enable/Disable Port Control	Yes, enables or disables serial, USB, audio, and network ports
Removable Media Write/Boot Control	Yes, prevents ability to boot from removable media on supported devices (and can disable writes to media)
Power-On Password	Yes, prevents an unauthorized person from booting up the workstation
Setup Password	Yes, prevents an unauthorized person from changing the workstation configuration
3.3V Aux Power LED on System PCA	Yes



,	CITCUITOTIS
NIC LEDs (integrated) (Green & Amber)	Yes
CPUs and Heatsinks	A T-15 Torx or flat blade screwdriver is needed to remove the CPU heatsink before the CPU can be removed. CPU removal is tool-less
Power supply diagnostic LED	Yes
Power Button	Yes, ACPI multi-function
Power LED	Yes, blue (normal), red (fault)
Hard drive activity LED	Yes, green
Internal speaker	Yes
System/Emergency ROM Flash Recovery	Recovers corrupted system BIOS.
OS CD (Restore OS CD)	Restores computer to its original factory shipping Operating System - No recovery CDs will ship with Windows XP, Vista or Linux - an ISO image will be available on an HD partition.
ASF 2.0 support (Alert Standard Format)	Industry-standard specification for network alerting in operating system-absent environments
Cooling Solutions	Air cooled forced convection, liquid cooling (optional)
Power Supply Fans	92 mm x 92 mm x 25 mm 2-wire (non-serviceable)
CPU Heatsink Fan(s)	Mainstream (<=95W): 80 mm x 80 mm x 15 mm 5-wire PWM Performance (>95W): 92 mm x 92 mm x 25 mm 5-wire PWM
Chassis Fans	92 mm x 92mm x 25 mm 4-wire PWM
Memory Fans	No
Insight Diagnostics	HP Insight Diagnostics Offline Edition The diagnostics utility enables you to perform testing and to view critical computer hardware and software configuration information from various sources. This utility enables you to:
	 Run diagnostics iew the hardware configuration of the system
	Key features and benefits HP Insight Diagnostics simplifies the process of effectively identifying, diagnosing, and isolating the hardware issues. In addition to robust management tools, service tools can be invaluable in quickly resolving system problems. To streamline the service process and resolve problems quickly, it is necessary to have the right information available at the time that a service call is placed. The primary information requirement, which is also the one that provides the greatest insight into potential system issues, is the configuration of the system. Insight Diagnostics helps provide higher system availability. Typical uses of the Insight Diagnostics are:
	 Testing and diagnosing apparent hardware failures Documenting system configurations for upgrade planning, standardization, inventory tracking, disaster recovery, and maintenance Sending configuration information to another location for more in-depth analysis
Access Panel Key Lock	No
ACPI-Ready Hardware	 Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode. Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system



Trusted Platform Module Chip with optional ProtectTools Software	Yes, Infineon SLB9635TT1.2
Integrated Chassis Handles	No
Power Supply	Requires T15 Torx or flat blade screwdriver
PCI Card Retention	Yes, rear (all), middle (none), front (full-length cards with extender)
Flash ROM	Yes
Diagnostic Power Switch LED on board	Yes
Clear Password Jumper	Yes
Clear CMOS Button	Yes
CMOS Battery Holder for easy Replacement	Yes
DIMM Connectors for easy Upgrade	Yes
HP ProtectTools Security Manager	Yes - Not supported on Microsoft XP x64 or Linux

DIGG	
BIOS	
BIOS 32-bit Services	Standard BIOS 32-bit Service Directory Proposal v0.4
PCI 3.0 Support	Full BIOS support for PCI Express through industry standard interfaces.
ATAPI	ATAPI Removable Media Device BIOS Specification Version 1.0.
BBS	BIOS Boot Specification v1.01.
WMI Support	WMI is Microsoft's implementation of Web-Based Enterprise Management (WBEM) for Windows. WMI is fully compliant with the Distributed Management Task Force (DMTF) Common Information Model (CIM) and WBEM specifications.
BIOS Boot Spec 1.01+	Provides more control over how and from what devices the workstation will boot.
BIOS Power On	Users can define a specific date and time for the system to power on.
ROM Based Computer Setup Utility (F10)	Review and customize system configuration settings controlled by the BIOS.
System/Emergency ROM Flash Recovery with Video	Recovers system BIOS in corrupted Flash ROM.
Replicated Setup	Saves BIOS settings to diskette or USB flash device in human readable file. Repset.exe utility can then replicate these settings on machines being deployed without entering Computer Configuration Utility (F10 Setup).
SMBIOS	System Management BIOS 2.6, for system management information.
Boot Control	Disables the ability to boot from removable media on supported devices.
Memory Change Alert	Alerts management console if memory is removed or changed.
Thermal Alert	Monitors the temperature state within the chassis. Three modes: NORMAL - normal temperature ranges ALERTED - excessive temperatures are detected. Raises a flag so action can be taken to avoid shutdown or provide for a smoother system shutdown



 	SHUTDOWN - excessive temperatures are encountered. Automatically shuts down the computer
	without warning before hardware component damage occurs
Remote ROM Flash	Provides secure, fail-safe ROM image management from a central network console.
ACPI (Advanced Configuration and Power Management Interface)	 Allows the system to enter and resume from low power modes (sleep states).] Enables an operating system to control system power consumption based on the dynamic workload. Makes it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system. Supports ACPI 2.0 for full compatibility with 64-bit operating systems.
Ownership Tag	A user-defined string stored in non-volatile memory that is displayed in the BIOS splash screen.
Remote Wakeup/Remote Shutdown	System administrators can power on, restart, and power off a client computer from a remote location.
ASF 2.0 Compliant	Allows workstation status to be monitored on a remote console.
Instantly Available PC (Suspend to RAM - ACPI sleep state S3)	Allows for very low power consumption with quick resume time.
Remote System Installation via F12 (PXE 2.1) (Remote Boot from Server)	Allows a new or existing system to boot over the network and download software, including the operating system.
ROM revision levels	Reports the system BIOS revision level in Computer Configuration Utility (F10 Setup). Version is available through an industry standard interface (SMBIOS) so that management SW applications can use and report this information.
System board revision level	 Allows management SW to read the revision level of the system board Revision level is digitally encoded into the HW and cannot be modified.
Start-up Diagnostics (Power-on Self-Test)	Assesses system health at boot time with selectable levels of testing.
Auto Setup when new hardware installed	System automatically detects addition of new hardware.
Keyboard-less Operation	The system can be booted without a keyboard.
Localized ROM Setup	Common BIOS image supports System Configuration Utility (F10 Setup) menus in 12 languages with local keyboard mappings.
Asset Tag	The user or MIS to set a unique tag string in non-volatile memory.
Per-slot Control	Allows I/O slot parameters (option ROM enable/disable, bus latency) to be configured individually.
Adaptive Cooling	Control parameters are set according to detected hardware configuration for optimal acoustics.
Pre-boot Diagnostics	(Pre-video) critical errors are reported via beeps and blinks on the power LED.
Industry Standard Specification Support	
Industry Standard	Revision Supported by the BIOS
ACPI	Advanced Configuration and Power Management Interface, Version 2.0c
ASF	Alert Standard Format Specification, Version 2.0
ATA (IDE)	AT Attachment 6 with Packet Interface (ATA/ATAPI-6), Revision 3b
CD Boot	"El Torito" Bootable CD-ROM Format Specification Version 1.0
EDD	 Enhanced Disk Drive Specification Version 1.1 BIOS Enhanced Disk Drive Specification Version 3.0



EHCI	Enhanced Host Controller Interface for Universal Serial Bus, Revision 1.0
PCI	 PCI Local Bus Specification, Revision 2.3 PCI Power Management Specification, Revision 1.1 PCI Firmware Specification, Revision 3.0, Draft .7
PCI Express	PCI Express Base Specification, Revision 2.0
PMM	POST Memory Manager Specification, Version 1.01
SATA	 Serial ATA Specification, Revision 1.0a Serial ATA 3.0Gb/s: Extensions to Serial ATA 1.5Gb/s, Revision 1.0
SPD	PC SDRAM Serial Presence Detect (SPD) Specification, Revision 1.2B
TPM	Trusted Computing Group TPM Specification Version 1.2
UHCI	Universal Host Controller Interface Design Guide, Revision 1.1
USB 1.1	Universal Serial Bus Revision 1.1 Specification
USB 2.0	Universal Serial Bus Revision 2.0 Specification
SMBIOS	System Management BIOS Reference Specification, Version 2.6

System Software Mo	anagement and Updating
HP Client Management Solutions	Visit: http://www.hp.com/go/easydeploy
Product Change	 Program to proactively communicate Product Change Notifications (PCNs) and Customer Advisories by email to customers, based on a user-defined profile. PCNs provide advance notification of hardware and software changes to be implemented in the factory providing time to plan for transition. Customer Advisories provide concise, effective problem resolution, greatly reducing the need to call technical support.
Support Software CD & WWW	Yes
HP Client Manager	Visit: http://www.hp.com/go/easydeploy
System Software Manager (free)	Visit: http://www.hp.com/go/ssm
Social and Environmental Responsibility	
	This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:
	 ENERGY STAR® (energy-saving features available on selected configurations -Windows only) US Federal Energy Management Program (FEMP) China Energy Conservation Program IT ECO declaration Japan PC Green label*
	*This product conforms to the examination standards (2003 version) under JEITA's 'PC Green Label System.'
Batteries	This product complies with ISO standards: • EU Directive 91/ 157/ EEC • EU Directive 93/ 86/ EEC • EU Directive 98/ 101/ EEC



System Technical Specifications

Batteries used in the product do not contain:

- Mercury greater than 5ppm by weight
- Cadmium greater than 10ppm by weight
- Lead greater than 4000ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium

Restricted Material Usage This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html):

- Asbestos
- Batteries Mercury
- Batteries Cadmium
- Batteries Lead (non-rechargeable)
- Batteries Non-rechargeable Alkaline and Carbon-Zinc Batteries
- Batteries Classification as "Not Restricted" for Transport
- Brominated Flame Retardants (PBBs, PBDEs, including DecaBDE)
- Brominated Flame Retardants (all BFRs in external case plastic parts)
- Cadmium and its compounds
- Certain Azo Colorants
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Formaldehyde emissions
- Hexavalent Chromium and its compounds in metallic applications
- Hexavalent Chromium and its compounds in non-metallic applications
- Lead and its compounds
- Lead in paint
- Lead in Polyvinyl Chloride (PVC) coating of external cables, wires and cords
- Mercury and its compounds
- Nickel on external surfaces
- Ozone Depleting Substances (ODS)
- Polycyclic Aromatic Hydrocarbons (PAH)
- Perfluorooctane sulfonates (PFOS) in parts
- Perfluorooctane sulfonates (PFOS) in preparations
- Polychlorinated Biphenyls (PCBs) and Polychlorinated Terphenyls (PCTs)
- Polychlorinated Naphthalenes
- Polyvinyl Chloride (PVC) in external case plastic parts
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

Packaging

HP Workstation product packaging meets the following (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen specifications.html:

- Does not contain restricted substances listed in HP Standard 011-1 General Specification for the Environment (see link above).
- Does not contain ozone-depleting substances (ODS).
- Design packaging materials for ease of disassembly.
- Does not contain heavy metals (lead, mercury, cadmium or hexavalent chromium) in excess of 100 ppm sum total for all heavy metals listed.



system rechnical spe	eneunons
	 Maximizes the use of post-consumer recycled content materials in packaging materials. All packaging material is recyclable. Reduces size and weight of packages to improve transportation fuel efficiency. Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
Longevity and Upgrading	This product is designed to be upgraded, possibly extending its useful life by several years. Spare parts are available throughout the warranty period and for up to 5 years after the end of production. Upgradeability features contained in the product include:
	Intel LGA775 processor socket
	• 12 USB ports
	O 7 rear
	O 3 internal - 1 Type A
	O 2 front
	3 PCI slots
	4 PCI Express slots
	O 1 PCI Express ×1 slot
	O 2 Gen2 PCI Express ×16 slots
Packaging Materials	
External	Cardboard carton and insert: 1.536 kg
Internal	LDPE Foam: .366 kg
End-of-Life Management	Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas.
and Recycling	To recycle your product, please go to: http://www.hp.com/recycle or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.
Hewlett-Packard	For more information about HP's commitment to the environment:
Corporate Environmental	[link to new HP white paper now in progress]
Information	Global Citizenship Report: http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html Eco-label certifications:
	http://www.hp.com/hpinfo/globalcitizenship/environment/productdesign/ecolabels.html ISO 14001 certificates:
	http://www.hp.com/hpinfo/globalcitizenship/environment/operations/envmanagement.html
Service, Support and Warranty	On-site Warranty and Service (Note 1): One and three-years, limited warranty and service offering delivers on-site, next business-day (Note 2) service for parts and labor and includes free telephone support (Note 3) 8am - 5pm. Global coverage (Note 2) ensures that any product purchased in one country and transferred to another, non-restricted country will remain fully covered under the original warranty and service
	offering NOTE 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. NOTE 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are
	based on commercially reasonable best effort and may vary by country.
	NOTE 3: Technical telephone support applies only to HP-configured, HP and HP-qualified, third-party hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.
	HP Care Pack Services extend service contracts beyond the standard warranties. Service starts from date of hardware purchase. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at http://www.hp.com/go/lookuptool. Additional HP Care Pack Services information by product is available at http://www.hp.com/hps/carepack. Service levels and response times for HP Care Packs may vary depending on your geographic location
Additional Information	This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2002/95/EC.
	 This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE)



System Technical Specifications

Directive - 2002/96/EC.

- Plastic parts weighing over 25 grams used in the product are marked per ISO 11469 and ISO1043.
- This product contains 0% recycled materials (by weight)
- This product is >90% recycle-able when properly disposed of at end of life.



Technical Specifications - Processors

Processors	Intel Xeon W3503, 2.40GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core
------------	---

Intel Xeon W3505, 2.53GHz, 4MB cache, 1066 memory, 4.8GT/s QPI, Dual-Core

Intel Xeon W3520, 2.66GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo Intel Xeon W3540, 2.93GHz, 8MB cache, 1066 memory, 4.8GT/s QPI, Quad-Core, HT, Turbo Intel Xeon W3570, 3.20GHz, 8MB cache, 1333 memory, 6.4GT/s, Quad-Core, HT, Turbo

Introduction

Intel's latest-generation microarchitecture represents the next step in unprecedented processor performance and dynamic scalability. Designed from the ground up to take advantage of hafnium-based Intel® 45nm hi-k metal gate silicon technology, Intel® Microarchitecture (Nehalem) unleashes parallel processing performance enabled by Intel® QuickPath technology providing an integrated memory controller and high-speed interconnect per independent processing core.

Performance and Features

Maximum multitasking performance Intel® Microarchitecture (Nehalem) offers the latest in processor innovation, including:

- 'Dynamic scalability, managed cores, threads, cache, interfaces, and power for energy-efficient performance on demand.
- Design and performance scalability for servers, workstations, notebooks and desktops with support for 2-8+ cores and up to 16+ threads with Intel® Hyper-Threading Technology (Intel® HT Technology), and scalable cache sizes, system interconnects, and integrated memory controllers.
- Intel® Turbo Boost Technology delivers additional performance automatically when needed by taking advantage of the
 processor's power and thermal headroom. This enables increased performance of both multi-threaded and single-threaded
 workloads.
- Intel Hyper-Threading Technology brings high-performance applications into mainstream computing with 1-16+ threads optimized for a new generation multi-core processor architecture.
- Scalable shared memory of Intel® QuickPath technology features memory distributed to each processor with integrated memory controllers and high-speed point-to-point interconnects to unleash the performance of future versions of next-generation Intel® multi-core processors.
- Multi-level shared cache improves performance and efficiency by reducing latency to frequently used data.

Turbo Boost Technology

This technology now built into Xeon 3500 Series Quad-Core processors will increase the speed of your processor on demand (from OS) if the CPU is operating below power / thermal specifications:

- Benefit of Turbo Boost (how much CPU speed up) depends on number of active cores
- Likelihood of Turbo Boost operation increases when less cores are active
- Likelihood of Turbo Boost operation increases when dynamic power mgt is enabled



Technical Specifications - Hard Drives

HP SAS (Serial Attached
SCSI) Hard Drives for HP
Workstations

300 GB (15K)

Capacity 300 GB
Height 1 in; 2.5 cm
Width Media Diam

Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads, includes controller overhead, including settling)Single Track overhead, including full Stroke0.2 msAverage overhead, including settling)Full Stroke6.7 ms

Rotational Speed 15,000 rpm

Logical Blocks 585,937,500 - 512 byte blocks **Operating Temperature** 50° to 95° F (10° to 35° C)

146 GB (15K)

Capacity 146 GB Height 1 in; 2.5 cm

 Width
 Media Diameter
 3.5 in; 8.9 cm

 Physical Size
 4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average
Full Stroke0.2 ms3.5 ms
6.7 ms

Rotational Speed 15,000 rpm

Logical Blocks 86,749,488 - 512 byte blocks Operating Temperature 50° to 95° F (10° to 3°5 C)

 450 GB
 Capacity
 450 GB

 (15K)
 Height
 1 in; 2.5 cm

 Width
 Media Diameter
 3.5 in; 8.9 cm

 Physical Size
 4 in; 10.2 cm

Interface SAS
Synchronous Transfer 3.0 Gb/s
Rate (Maximum)

Buffer 16 MB

Technical Specifications - Hard Drives

Seek Time (typical reads,
includes controller
overhead, including
settling)Single Track
Average0.2 msAverage
Full Stroke3.6 ms6.6 ms

Rotational Speed 15,000 rpm

Logical Blocks 879, 097, 968 - 512 byte blocks Operating Temperature 50° to 95° F (10° to 35° C)

SATA (Serial ATA) Hard 160,041,885,696

Drives for HP Workstations bytes (10K) **Capacity** 160,041,885,696 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm
Physical Size 4 in; 10.2 cm

Up to 150 MB/s

Interface Serial ATA (1.5 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Buffer

16 Mbytes

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average0.3 msAverage
Full Stroke4.6 ms10.2 ms

Rotational Speed 10,000 rpm Logical Blocks 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)

1,000,204,886,016

bytes (7,200)

Capacity 1,000,204,886,016 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer

Rate (Maximum)

Up to 300 MB/s

Buffer 32 MB

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average2 msAverage
Full Stroke11 ms21 ms

Rotational Speed 7,200 rpm Logical Blocks 1,953,525,168

Operating Temperature 41° to 131° F (5° to 55° C)

500,107,862,016 Capacity 500,107,862,016 bytes



Technical Specifications - Hard Drives

bytes Height 1 in; 2.5 cm (7,200)

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled 300 MB/s

Synchronous Transfer

Rate (Maximum)

Buffer 16 MB

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average2 msAverage
Full Stroke11 ms21 ms

Rotational Speed 7,200 rpm **Logical Blocks** 976,773,168

Operating Temperature 41° to 131° F (5° to 55° C)

250 GB

(7200 rpm, for HP Z-Workstations)

Capacity 250 GB

Height 1 in; 2.54 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer 300 MB/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typicalSingle Track2 msreads, includes
controller overhead,
including settling)Average11 msFull Stroke21 ms

Rotational Speed 7,200 rpm Logical Blocks 488,397,168

Operating Temperature 41° to 131° F (5° to 55° C)

160,041,885,696

bytes (7,200)

Capacity 160,041,885,696 bytes

Height 1 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4 in; 10.2 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer 300 MB/s

Rate (Maximum)

Buffer 8 MB



Technical Specifications - Hard Drives

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average2 msAverage
Full Stroke11 ms21 ms

Rotational Speed 7,200 rpm Logical Blocks 312,581,808

Operating Temperature 41° to 131° F (5° to 55° C)

300,069,052,416

bytes (10K) **Capacity** 300,069,052,416 bytes

Height 0.6 in; 1.53 cm

Width Media Diameter 2.5 in; 6.36 cm

Physical Size 4 in; 10.17 cm

Interface Serial ATA (3.0Gb/s), Native Command Queuing

enabled

Synchronous Transfer Up to 300 MB/s

Rate (Maximum)

Buffer 16 MB

Seek Time (typical Single Track 0.7 ms (maximum)

reads, includes controller overhead, including settling)

Average 4.4 ms

Full Stroke 9.5 ms

Rotational Speed 10,000 rpm Logical Blocks 586,072,368

Operating Temperature 41° to 131° F (5° to 55° C)

320,072,933,376

bytes (7,200)

Capacity 320,072,933,376 bytes

Height 0.98 in; 2.5 cm

Width Media Diameter 3.5 in; 8.9 cm

Physical Size 4.0 in; 10.17 cm

Interface Serial ATA (3.0 Gb/s), Native Command Queuing

enabled

Synchronous Transfer 300 MB/s

Rate (Maximum)

Buffer 8 MB

Seek Time (typical
reads, includes
controller overhead,
including settling)Single Track
Average2Full Stroke21

Rotational Speed 7,200 rpm Logical Blocks 625,142,448

Operating Temperature 41° to 131° F (5° to 55° C)

Technical Specifications - Hard Drive Controllers

LSI 3041E 4-Port SAS 3.0 PCI Bus PCI-Express x4 lanes Gb/s RAID Card PCI Modes Bus Master DMA

RAID Levels RAID 0, 1, 1E and 10E

PCI Data Burst Transfer

Rate

250 MB/s per lane half duplex 500 MB/s per lane full duplex 1,000 MB/s 4-lane half duplex

SAS Bandwidth Half Duplex Single lane – 300 MB/s

Wide Port (2 lanes) – 600 MB/s Wide Port (4 lanes) – 1200 MB/s

Full Duplex Single SAS Lane – 600 MB/s

Wide Port (2 lanes) –1200 MB/s Wide Port (4 lanes) – 2400 MB/s

PCI Card Type3.3 volt add-in cPCI Voltage $12 \text{ V} \pm 10\%$ PCI Power7.5 Watts

Bracket Full height and Low-profile

Certification Level PCI-Express 1.0a

IO Bus Four 3 Gb/s SAS/SATA ports

SAS Processor LSISAS1064E

Internal Connectors Four- SATA x1 connectors

External Connectors None
Maximum Number of 122

SCSI Devices

LED Indicators On-board activity and fault LEDs

Integrated Mirroring Integrated Mirroring option available

LSI MegaRAID® SAS 8888ELP Host Bus Adapter (HBA) PCI Bus
PCI-Express x8 lanes
PCI Modes
Bus Master DMA
RAID Levels
RAID 0, 1, and 5
RAID spans 10 and 50

PCI Data Burst Transfer

Rate

Up to 3Gb/s per port

Full Duplex Up to 1.5 GB/s
PCI Voltage +3.3V Add-in Card

PCI Power 7.5 Watts

Certification Level PCI-Express 1.0a

IO Bus Eight 3Gb/s SAS/SATA ports

Internal Connectors Two SAS SFF8087 x4
External Connectors Two SAS SFF8088 x4

Maximum Number of

SCSI DeviceS

32



Technical Specifications - Hard Drive Controllers

LED Indicators

Connector LEDs indicate whether the internal or external connector is active for ports 0-3 and 4-7



Technical Specifications - Graphics

NVIDIA Quadro NVS 450 Form Factor

ATX Full Height, 1/2 length

512 MB PCle Graphics

Passive cooling

Card

Bus Type PCI Express x16, Generation 2.0

Memory 512 MB GDDR3 (256MB per GPU)

Connectors Four DisplayPort;

Four DisplayPort to DVI-D adapters included.

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution DisplayPort connectors support ultra-high-resolution panels (up to 2560 x

1600)

Supported Graphics APIs OpenGL 3.0

Direct X 10.0

Available Graphics

Drivers

Genuine Microsoft Windows Vista(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support web

site: http://welcome.hp.com/country/us/eng/software_drivers.html.
Novell SUSE Linux Enterprise drivers may be obtained from:
ftp://download.nvidia.com/novell or http://www.nvidia.com

Power consumption 35 Watts

NVIDIA Quadro NVS 295 Form Factor

256MB Graphics Card

2.731 inches (H) \times 6.600 inches (L), Half-Height NVIDIA Quadro NVS 295 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort

Comes with 2 DisplayPort to DVI-D Adapters

('DisplayPort to VGA' and 'DisplayPort to DL DVI' adapters available as an

accessory)

Maximum Resolution

Graphics Controller

Display Output

Two DisplayPort outputs drive two digital displays up to 2560 x 1600

Drives DisplayPort enabled digital displays at resolutions up to 2560

 \times 1600 at 60 Hz with reduced blanking

 \bullet Drives DVI enabled digital displays at resolutions up to 1920×1200 at 60 Hz with reduced blanking (through DisplayPort to DVI-D (single

link) cable)

Supported Graphics APIs

OpenGL 3.0

DirectX 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from:



Technical Specifications - Graphics

ftp://download.nvidia.com/novell or http://www.nvidia.com

22.69 Watts Power consumption

NVIDIA Quadro NVS 290 Form Factor 256 MB PCle Graphics Card

Bus Type

Low Profile PCle x16

Memory 256 MB 400MHz DDR2 SDRAM unified frame buffer, Z-buffer and Texture

storage

Connectors DMS-59, includes DMS-59 to Dual DVI-I cable. DMS-59 to Dual VGA cable

available as an option.

Maximum Resolution Dual integrated analog display controllers supporting up to two analog

displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft® Windows®

RAMDAC Integrated dual 400MHz

Image Quality Features Full-screen, full-frame video playback of HDTV and DVD content

DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Programmable Video

Processor

Full-screen, full-frame video playback of HDTV and DVD content

DVD-ready motion compensation for MPEG-2

Independent hardware color controls for video overlay Hardware color-space conversion (YUV 4:2:2 and 4:2:0)

IDCT motion compensation

5-tap horizontal by 3-tap vertical filtering

8:1 up/down scaling

Display Output Dual integrated analog display controllers supporting up to two analog

displays at 2048x1536 @ 85Hz on both displays or dual digital displays at

1920x1200 (single-link).

NVIEW advanced multi-display desktop and application management

seamlessly integrated into Microsoft® Windows®

Supported Graphics APIs

OGL 2.1 & DX10 Support; Shader Model 4.0

Drivers

Available Graphics Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)(Provides full native Dual View mode, Span or

Big Desktop mode, and Clone mode)

Red Hat Enterprise Linux(RHEL) WS3, WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support web

site: http://welcome.hp.com/country/us/eng/software drivers.html. Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-Resolution AntiAliasing

Color planes: 32-bit color buffer Overlay planes: Hardware supported



Technical Specifications - Graphics

CUDA™ Parallel Processor Cores NVIDIA Quadro NVS 290 (256 MB DH) PCIe Graphics Card with full height bracket attached, DMS-59 to Dual DVI cable, Workstation Software Driver

CD, documentation.

NVIDIA Quadro FX 380 256MB Graphics Card Form Factor 4.376 inches (H) \times 6.60 inches (L)

Graphics Controller NVIDIA Quadro FX 380 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 Dual Link DVI-I

Two DVI-I to VGA adapters included

Maximum Resolution Two dual-link DVI-I outputs drive two digital displays at resolutions up to

 $2560 \ x \ 1600 \ @ \ 60 Hz$ or two analog displays at resolutions up to $2048 \ x$

1536 @ 85Hz

RAMDAC Dual Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site: http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages Optimized compiler for Cg and Microsoft HLSL

• OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel Processor Cores 16

Power consumption

33.91 Watts

Technical Specifications - Graphics

ATI FirePro V3700 256MB Graphics Card Form Factor 4.40 inches (H) \times 6.70 inches (L) (11.18 cm (H) \times 17.02 cm (L))

Graphics Controller ATI FirePro V3700 Graphics Board Bus Type PCI Express x16, Generation 2.0

Memory 256 MB GDDR3 SDRAM unified graphics memory

Connectors 2 Dual Link DVI-I

Two DVI-I to VGA adapters included

Maximum Resolution Two dual-link DVI-I outputs drive two digital displays at resolutions up to

2560 x 1600 @ 60Hz or two analog displays at resolutions up to 2048 x

1536 @ 85Hz

Shading architecture Full Shader Model 4.0

40 Stream Processing Units

 Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

 Common instruction set and texture unit access supported for all types of shaders

• Dedicated branch execution units and texture address processors

Supported graphics APIs OpenGL 2.1

DirectX 10.1

Available graphics drivers Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from: http://ati.amd.com/support/driver.html

Power consumption 32 Watts

NVIDIA Quadro FX 580 512MB Graphics Card Form Factor 4.376 inches (H) \times 6.60 inches (L)

Graphics Controller NVIDIA Quadro FX 580 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 512MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)

dii decesso

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

RAMDAC Single Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)



Technical Specifications - Graphics

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs

OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

32

Power consumption

40 Watts

NVIDIA Quadro FX 1800 Form Factor 768MB Graphics Card

4.376 inches (H) x 7.8 inches (L)

Graphics Controller

NVIDIA Quadro FX 1800 Graphics Board

Bus Type

PCI Express x16, Generation 2.0

Memory

768MB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI-D and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

• One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

RAMDAC

Single Internal 400 MHz DAC

Shading Architecture

Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

- Long fragment programs (unlimited instructions)
- Long vertex programs (unlimited instructions)
- Looping and subroutines (up to 256 loops per vertex program)
- Dynamic flow control
- Conditional execution

Supported Graphics APIs

OpenGL 3.0

Direct X 10.0

Available Graphics Drivers

Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP Professional(64-bit and 32-bit)



Technical Specifications - Graphics

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

64.

Power consumption

59 Watts

ATI FirePro V5700 512MB Graphics Card Form Factor

4.40 inches (H) \times 6.70 inches (L) (11.18 cm (H) \times 17.02 cm (L))

Graphics Controller

ATI FirePro V5700 Graphics Board PCI Express x16, Generation 2.0

Bus Type Memory

512 MB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

Shading architecture

Full Shader Model 4.0

320 Stream Processing Units

 Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

Common instruction set and texture unit access supported for all types of shaders

Dedicated branch execution units and texture address processors

Supported graphics APIs

OpenGL 2.1

DirectX 10.1

Available graphics drivers Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from: http://ati.amd.com/support/driver.html

Power consumption



Technical Specifications - Graphics

NVIDIA Quadro FX 3800 Form Factor 1.0GB Graphics Card (NOT AVAILABLE UNTIL JUNE 2009) Graphics Co

Form Factor 4.376 inches (H) x 9.0 inches (L)

Single slot card

Graphics Controller NVIDIA Quadro FX 3800 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 1GB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI-D and one DVI to VGA adapter included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

 One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to 2048 x 1536 @ 85Hz

Single Internal 400 MHz DAC

RAMDAC Single Internal 400 MHz DAC

Shading architecture Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported graphics APIs OpenGL 3.0

Direct X 10.0

Available graphics drivers Genuine Windows Vista Business(64-bit and 32-bit), Microsoft Windows XP

Professional(64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-level Shader Languages Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel Processor Cores

192

Power consumption 107.9 Watts

Technical Specifications - Graphics

ATI FirePro V7750 1.0GB Form Factor

Graphics Card

Graphics Controller

ATI FirePro V7750 Graphics Board

Bus Type PCI Express x16, Generation 2.0

Memory 1024 MB GDDR3 SDRAM unified graphics memory

Connectors 2 DisplayPort, 1 Dual-Link DVI-I.

One DisplayPort to DVI and one DVI to VGA adapter included

4.40 inches (H) \times 13.0 inches (L) (11.18 cm (H) \times 33.02 cm (L))

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• Two DisplayPort outputs drive two digital displays up to 2560 x 1600

One dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz or one analog display at resolutions up to

2048 x 1536 @ 85Hz

Shading architecture

Full Shader Model 4.0

• 320 Stream Processing Units

Dynamic load balancing and resource allocation for vertex, geometry, and pixel shaders

Common instruction set and texture unit access supported for all types of shaders

Dedicated branch execution units and texture address processors

Supported graphics APIs

OpenGL 2.1

DirectX 10.1

Available graphics drivers Genuine Windows Vista Business (64-bit and 32-bit)

Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Linux drivers may be obtained from:

http://ati.amd.com/support/driver.html

Power consumption



Technical Specifications - Graphics

NVIDIA Quadro FX 4800 Form Factor

1.5GB PCle Graphics Card

Graphics Controller

Bus Type PCI Express x16, Generation 2.0

Memory 1.5 GB GDDR3 SDRAM unified graphics memory

4.36" (H) x 10.5" (L)

Dual slot card

2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output, Two Connectors

DisplayPort to DVI-D adapters included

NVIDIA Quadro FX 4800 graphics board

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution • 2 DisplayPort connectors support ultra-high-resolution panels (up to

2560 x 1600)

Dual-link DVI-I output drives one digital display at resolutions up to

2560 x 1600 @ 60Hz

Internal 400 MHz DACs-One analog display up to 2048 x 1536 @

85Hz

Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class) Shading Architecture

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

OpenGL 3.0 Supported Graphics APIs

Direct X 10.0

Available Graphics Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

Red Hat Enterprise Linux(RHEL) WS4 & 5 Desktop/Workstation

HP qualified drivers may be preloaded or available from the HP support

Web site:

http://welcome.hp.com/country/us/en/support.html

Novell SUSE Linux Enterprise drivers may be obtained from: ftp://download.nvidia.com/novell or http://www.nvidia.com

High-Resolution **AntiAliasing**

Rotated Grid Full-Scene Antialiasing (RG FSAA)

32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200

64x FSAA SLI Mode

High-level Shader

Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

192

Power consumption



Technical Specifications - Graphics

NVI	DIA	Quad	dro	CX
1 7 7 1				

Form Factor 4.36" (H) x 10.5" (L)

Dual slot card

Graphics Controller

NVIDIA Quadro CX 1.5GB Graphics Card

Bus Type

PCI Express x16, Generation 2.0

Memory

1.5 GB GDDR3 SDRAM unified graphics memory

Connectors

2 DisplayPort, 1 Dual-Link DVI-I, 1 3-pin Mini DIN stereo output.

Two DisplayPort to DVI-D adapters included

('DisplayPort to VGA' and 'DisplayPort to Dual Link DVI' adapters available as

an accessory)

Maximum Resolution

• 2 DisplayPort connectors support ultra-high-resolution panels (up to 2560 x 1600)

• Dual-link DVI-I output drives one digital display at resolutions up to 2560 x 1600 @ 60Hz

Internal 400 MHz DACs-One analog display up to 2048 x 1536 @ 85Hz

RAMDAC

400MHz

Shading Architecture

• Full Shader Model 4.0 (OpenGL 2.1/DirectX 10 class)

Long fragment programs (unlimited instructions)

Long vertex programs (unlimited instructions)

Looping and subroutines (up to 256 loops per vertex program)

Dynamic flow control

Conditional execution

Supported Graphics APIs

OpenGL 3.0 Direct X 10.0

Available Graphics

Drivers

Genuine Windows Vista Business (64-bit and 32-bit) Microsoft Windows XP Professional (64-bit and 32-bit)

HP qualified drivers may be preloaded or available from the HP support Web site:

http://welcome.hp.com/country/us/en/support.html

High-Resolution AntiAliasing

Rotated Grid Full-Scene Antialiasing (RG FSAA)

32xFSAA dramatically reduces visual aliasing artifacts or "jaggies" at resolution up to 1920 x 1200

64x FSAA SLI Mode

High-level Shader Languages

Optimized compiler for Cg and Microsoft HLSL

OpenGL 2.1 and DirectX 10 support

Open source compiler

CUDA™ Parallel **Processor Cores**

192

Power consumption

Technical Specifications - Multimedia and Audio Devices

Integrated Intel/Realtek HD ALC262 Audio Type Integrated

High Definition Codec Yes
FM Synthesis Support Yes
OPL3 FM Synthesis Yes

Support

Sound Blaster Yes

Compatibility

Meets Premium Yes performance for Windows Logo Program 3.0

Audio Jacks Front panel microphone in and headphone out - fixed usage.

Rear panel line in and line out jacks - jacks are retaskable

One Line-In* (12-K ohm Input Impedance)*

NOTE: External Speakers need to be powered externally.

Sampling 3 stereo ADCs support 16/20-bit PCM format with 44.1K/48K/96kHz

sample rate

2 stereo DAC supports 16/20/24-bit PCM format with

44.1K/48K/96K/192kHz sample rate

Wavetable Syntheses

(software)

Yes – GM and FM Midi Support, Direct Music and Down Loadable Soundset

(4 Meg DLS Level 1 and 2 Support)

3D Positional Sound No
Digital Audio Yes
Analog Audio Yes
DVD Audio Yes

Number of Channels on

Line-Out

Stereo (Left & Right channels)

Internal Audio Speaker

D. D. C.

1.5 W

Power Rating

Internal Speaker Hardware Equalizer for

Internal Speaker

Yes No

External Speaker Jack

Yes

(Line-Out)

Technical Specifications - Multimedia and Audio Devices

HP Thin USB Powered Speakers

Frequency Response (-3dB, 24-bit/96kHz input) FO to 20kHz

Dimensions

Power LED

Watts

Speakers: 5.72 x 3.74 x 0.96 in (14.52 x 9.50 x 2.45 cm) per speaker

On/Off/Volume Controls Right side of right speaker

Front of right speaker (green) 2/3 watt (normal/maximum)

0.68 lbs (0.31kg) Net weight

Environmental (all **Temperature** (operating): 14° to 104° F (-10° to 40° C)

conditions non-Relative Humidity 40% to 90%

condensing) (operating):

Input cord: 5.91 ft (1800mm±35mm) Speaker cable length

L-channel cord: 3.28 ft (1000mm±35mm) USB cord: 5.91 ft (1800mm±35mm)

Color **HP** Carbonite

Kit Contents One pair of HP Thin USB Powered Speakers with attached audio signal and

USB power cables for connecting to your PC

HP Warranty documentation

96kHz sample rate

SoundBlaster (Creative Labs) X-Fi Titanium PCle Audio Card

24-bit Analog-to-Digital

conversion of analog

inputs

24-bit Digital-to-Analog conversion of digital

sources

96kHz to analog 7:1 speaker output

8, 11.025, 16, 22.05, 24, 32, 44.1, 48 and 96kHz

24-bit Digital-to-Analog conversion of stereo digital sources

16-bit to 24-bit recording 16-bit/44.1kHz, 16-bit/48kHz, 24-bit/44.1kHz, 24-bit/48kHz and 24-

bit/96kHz with direct monitoring sampling rates

Enhanced SoundFont

support

Up to 24-bit resolution

Signal-to-Noise Ratio 109dB

(2okHz Low-pass filter, A-

Weighted)

Total Harmonic Distortion .004%

+ Noise at 1kHz (20kHz

Low-pass filter)

Frequency Response (-

10Hz to 46kHz

3dB, 24-bit/96kHz input)

Frequency Response (-10Hz to 46kHz

3dB, 24-bit/192kHz input)

Speaker and Headphone Stereo to 7.1 (Line Out via three 3.5mm mini jacks)

connections

Flexijack Line In/ Microphone In/Optical Out via shared 3.5mm mini jack

Front Panel Header Intel HD Audio Compatible (2x5 pin)



Technical Specifications - Multimedia and Audio Devices

Operating System Microsoft Windows Vista Business 64

Microsoft Windows Vista Business 32

Microsoft® Windows® XP Professional SP2 Microsoft Windows XP Professional x64 Edition

Minimum System System RAM 512MB

Requirements Operating System Windows Vista 32-bit and 64-bit version or

Windows XP 32-bit or 64-bit version



Technical Specifications - Optical and Removable Storage

NOTE 1: Actual speeds may vary. Does not permit copying of commercially available DVD movies or other copyright protected materials. Intended for creation and storage of your original material and other lawful uses. Double Layer discs can store more data than single layer discs. However, double-layer discs burned with this drive may not be compatible with many existing single-layer DVD drives and players.

HP DVD-ROM Drive	Description	5.25-inch, half-height, tray-load
------------------	-------------	-----------------------------------

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Disc Capacity DVD-ROM Single layer: Up to 4.7 GB Double layer: Up to

8.5 GB

Access Times DVD-ROM Single Layer < 140 ms (typical)

CD-ROM Mode 1 < 125 ms (typical)

Full Stroke DVD < 250 ms (seek)

Full Stroke CD < 210 ms (seek)

Power SATA DC power receptacle

DC Power Requirements 5 VDC \pm 5%-100 mV ripple p-p

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC - <1000 mA typical, < 1600 mA

maximum

12 VDC - < 600 mA typical, < 1400 mA

maximum

Operating Environmental Temperature 41° to 122° F (5° to 50° C)

(all conditions noncondensing)

Relative Humidity

10% to 90%

Maximum Wet Bulb

86° F (30° C)

Maximum Wet Bulb 86° F (30° (Temperature

Operating Systems Windows Vista Business 64* Windows Vista Supported Business 32*, Windows Vista Home Basic 32*,

Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS3, WS4, 5

Desktop/Workstation Novell SLES 9 & SLE 10

No driver is required for this device. Native support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit:

http://www.windowsvista.com/

upgradeadvisor. For Windows Vista system

requirements, visit:

http://www.windowsvista.com/

systemrequirements.



Technical Specifications - Optical and Removable Storage

HP DVD+/-RW Drive	Description	5.25-inch, half-height, tray-load
-------------------	-------------	-----------------------------------

Mounting Orientation Either horizontal or vertical

Interface Type SATA/ATAPI

Dimensions (WxHxD) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Disc Formats DVD-RAM

> DVD+RDVD+RWDVD+R DL DVD-R DL DVD-R DVD-RW CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Maximum Data Transfer

Rates

CD ROM Read CD-ROM, CD-R Up to 40X

CD-RW Up to 32X

DVD ROM Read DVD-RAM Up to 12X

DVD+RWUp to 8X DVD-RW Up to 8X DVD+R DL Up to 8X DVD-R DL Up to 8X DVD-ROM Up to 16X DVD-ROM DL Up to 8X DVD+RUp to 16X DVD-R Up to 16X

Power Source SATA DC power receptacle

> DC Power Requirements $5 \text{ VDC} \pm 5\%\text{-}100 \text{ mV ripple p-p}$

 $12 \text{ VDC} \pm 5\%$ -200 mV ripple p-p

DC Current 5 VDC -1000 mA typical, 1600 mA maximum 12 VDC -600 mA typical, 1400 mA maximum

41° to 122° F (5° to 50° C)

Operating Environmental Temperature (all conditions non-Relative Humidity 10% to 90%

condensing)

Maximum Wet Bulb

Temperature

Windows Vista Business 64*, Windows Vista **Operating Systems** Supported Business 32*, Windows Vista Home Basic 32*,

86° F (30° C)

Windows 2000, Windows XP Professional or

Windows XP Home 32*.

Red Hat Enterprise Linux(RHEL) WS3, WS4, 5

Desktop/Workstation Novell SLES 9 & SLE 10

No driver is required for this device. Native



Technical Specifications - Optical and Removable Storage

support is provided by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit: http://www.windowsvista.com/ systemrequirements.

* LightScribe functionality is not natively supported by Linux distributions. Customers may download LightScribe Linux drivers from: http://www.lightscribe.com/

downloadSection/linux/index.aspx

Kit Contents

HP SATA SuperMulti LightScribe DVD Writer drive, LightScribe software, Roxio Easy Media Creator software, Intervideo WinDVD Software, installation guide, and DVD+R media.

HP Blu-Ray Writer

Description 5.25-inch, half-height, tray-load Mounting Orientation Either horizontal or vertical

SATA Interface Type

Dimensions (WxHxD) 5.9 x 1.7 x 8.0 in (15.0 x 4.4 x 20.3 cm)

Disc Formats BD-ROM

BD-R BD-RE DVD-RAM DVD+RDVD+RWDVD+R DL DVD-R DL DVD-R DVD-RW

CD-R CD-RW

Disc Capacity DVD-ROM 8.5 GB DL or 4.7 GB standard

> 50 GB DL or 25 GB standard Blu-ray

Full Stroke DVD < 250 ms (seek) Full Stroke CD < 210 ms (seek)

Blu-ray Blu-ray

Startup Time (Time to BD-ROM (SL/DL) 25\$ / 28\$ drive ready from tray BD-R (SL/DL) 25\$ / 28\$ loading) BD-RE (SL/DL) 25\$ / 28\$

DVD-ROM (SL/DL) 18S / 18S



Technical Specifications - Optical and Removable Storage

·	-			
		DVD-R (SL/DL)	25\$ / 25\$	
		DVD-RW	25\$	
		DVD+R (SL/DL)	25\$ / 25\$	
		DVD+RW	25\$	
		DVD-RAM	45S	
		CD-ROM	45S	
Maximum Data Transfer	CD ROM Read	CD-ROM	Up to 40X	
Rates		CD-R CD-RW	Up to 40X	
	DVD ROM Read	DVD-RAM	Up to 40X	
	DVD KOM Kedd	DVD+RW	Up to 5X	
		DVD+RW	Up to 10X	
		DVD+R DL	Up to 10X	
		DVD+R DL DVD-R DL	Up to 8X Up to 8X	
		DVD-R DL DVD-ROM	•	
		DVD-ROM DL	Up to 16X Up to 8X	
		DVD+R	Up to 12X	
		DVD-R	Up to 12X	
	Blu-Ray	BD-ROM	Up to 6X	
	Dio Ray	BD-ROM DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-R DL	Up to 4.8X	
		BD-R	Up to 6X	
		BD-RE SL/DL	Up to 4.8X	
Power	Source	SATA DC power receptacle		
	DC Power Requirements	5 VDC ± 5%-100 mV ripple p-p 12 VDC ± 10%-100 mV ripple p-p		
	DC Current	5 VDC -900 mA typical, 1200 mA maximum 12 VDC -1000 mA typical, 1600 mA maximum		
Operating Environmental	Temperature	41° to 122° F (5° to 50° C)		
(all conditions non-	Relative Humidity	15% to 80%		
condensing)	Maximum Wet Bulb Temperature	86° F (30° C)		
	Operating Systems Supported	Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP Home 32*. Red Hat Enterprise Linux(RHEL) WS3, WS4, 5 Desktop/Workstation Novell SLES 9 & SLE 10		
		No driver is required for this device. Native		



support is provided by the operating system.

Technical Specifications - Optical and Removable Storage

Kit Contents HP Blue Laser RW Drive, LightScribe software,

Roxio Easy Media Creator software, Intervideo

WinDVD Software, installation guide.

Disclaimer As Blu-Ray is a new format containing new technologies, certain disc, digital

connection, compatibility and/or performance issues may arise, and do not constitute defects in the product. Flawless playback on all systems is not guaranteed. In order for some Blu-Ray titles to play, they may require a DVI or HDMI digital connection and your display may require HDCP support.

HD-DVD movies cannot be played on this workstation.

HP 22-in-1 Media Card

Reader

The Media Card Reader device uses the same physical form factor and

mounting as a Floppy Disk Drive. The device connects to a 2x5 two-channel USB header on the motherboard of the system. There is no USB controller card provided. Please see the Disc Formats section below for a list of flash

memory card formats that are supported.

Mounting Orientation The Media Card Reader can be mounted in a dedicated Floppy Drive bay (if

the chassis provides one) or in an appropriate Optical Bay adapter. It will

operate in any orientation.

Interface Type USB 2.0 (one channel dedicated to the separate USB port; one channel

dedicated to the flash memory card slots)

Dimensions (WxHxD)

Description

4.9 x 4.0 x 1.0 in (124.5 x 101.6 x 25.4 mm)

Disc Formats

xD-Picture Micro SD

Micro SDHC

MICIO SDITC

SD SDHC Mini SD

Mini SDHC

MultiMediaCard (MMC)

Reduced Size MultiMediaCard (RS MMC)

MultiMedia Card 4.2 (MMC Plus, including MMC Plus HC)

Reduced Size MultiMedia Card 4.2 (MMC Mobile, including MMC Mobile

HC)

CompactFlash Card Type I

CompactFlash Card Type II

MicroDrive

Memory Stick (MS)

MagicGate Memory Stick (MG)

MagicGate Memory Stick Duo

Memory Stick Select

Memory Stick Duo (MS Duo) Memory Stick PRO (MS PRO)

Memory Stick PRO Duo (MS PRO Duo)

Memory Stick PRO-HG Duo

Two additional formats are usable with adapters (not supplied):

MMC Micro

Memory Stick Micro (M2)



Technical Specifications - Controller Cards

HP FireWire/IEEE 1394a Data Transfer Rate
PCI Card Davids Interface Pr

Data Transfer Rate Burst Data Rate up to 400 Mbps

Device Interface Protocol IEEE-1394a

Devices Supported IEEE-1394 compliant devices

Bus Type PCI card with brackets for low profile and full height PCI slots.

Certification Level FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

STD, Taiwan BSMI CNS13438, Korea MIC

Ports Two IEEE 1394 6-Pin Connector (Rear)

Internal Connectors One 10-Pin (9 Contacts) Custom Connector

System Requirements Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista

Home Basic 32^* , Windows 2000, Windows XP Professional or Windows XP Home 32^* . No driver is required for this device. Native support is provided

by the operating system.

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista system requirements, visit:

http://www.windowsvista.com/systemrequirements.

Pentium II 266 or above

128-MB RAM 1-GB Hard Drive CD-ROM drive Built-in sound system Available PCI slot

Temperature - Operating 50° to 131° F (10° to 55° C)

Temperature - Storage -22° to 140° F (-30° to 60° C)

Relative Humidity -

Operating

20% to 80%

Operating Systems

Supported

Windows Vista Business 64*, Windows Vista Business 32*, Windows Vista Home Basic 32*, Windows 2000, Windows XP Professional or Windows XP

Home 32*

* Certain Windows Vista product features require advanced or additional hardware. Windows Vista Upgrade Advisor can help you determine which features of Windows Vista will run on your computer. To download the tool, visit: http://www.windowsvista.com/upgradeadvisor. For Windows Vista

system requirements, visit:

http://www.windowsvista.com/systemrequirements.



Technical Specifications - Controller Cards

HP IEEE 1394b FireWire PCle Card

Data Transfer Rate **Devices Supported**

Supports up to 800 Mbps IEEE-1394 compliant devices PCIe card full height PCIe slots

Bus Type Ports

Two IEEE-1394b bilingual 9-Pin Connector (Rear)

Internal Connectors

One 10-Pin header Custom Connector

System Requirements

Microsoft Windows XP Professional, Windows XP Home, Windows Vista. Not supported on Linux. Pentium® III or higher processor 128-MB RAM 1-GB Hard Drive CD-ROM drive Built in sound system Available PCI slot

FCC Part 15B, cULus 60950, CE Mark EN55022B(1995)/EN55024-1998

Temperature – Operating 50° to 131° F (10° to 55° C) Temperature – Storage

-22° to 140° F (-30° to 60° C)

Relative Humidity -

20% to 80%

Operating Compliances

STD, Taiwan BSMI CNS13438, Korea MIC Microsoft Windows XP and Windows Vista

Operating Systems

Supported

Technical Specifications - Networking and Communications

NOTE 1: "Gigabit" Ethernet indicates compliance with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/sec. For high speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.

Integrated Broadcom 5764 PCle LOM Controller Connector RJ45

Data Rates Supported 10/100/1000BT

Bus Architecture PCle X1
Alerting ASF 2.0

Broadcom (5761) NetXtreme Gigabit Ethernet Plus NIC

Connector RJ-45

Controller Broadcom 5761 PCI-Express LAN Controller

Memory 8 MB NVRAM serial Flash
Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB, 802.3u, and 802.3x

Bus Architecture PCI-Express

Data Path Width Single Channel PCI-Express

Data Transfer Mode Bus Master DMA

Hardware Certifications FCC class B, Canada and US NRTL Mark, C-Tick for Australia, BSMI for

Taiwan, VCCI for Japan, MIC for Korea, GOST for Russia, UL listed

(E212044), European Union Notice (CE 0682)

Power Requirement 1.8W @ 3.3V

Boot ROM Support Yes

Network Transfer Mode Full-duplex

Half-duplex (not available for the 1000BASE-T transceiver)

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)

Operating Humidity 131° F (55° C) with 5% to 95% non-condensing humidity

Dimensions 2.75 in x 4.13 in (7 cm x 10.5 cm), low profile compatible

Operating System Driver Windows Vista 32-bit SP1, Windows Vista x64 SP1, Windows XP 32 bit

Support professional, Windows XP x64.

Management Capabilities ACPI, WOL and DMI 2.0, PXE 2.0, WfM 2.0, Broadcom mgmt utility,

ASF2.0, DASH 1.0 and DASH 1.1 profiles

Kit Contents Broadcom NetXtreme Gigabit Ethernet Plus NIC, Broadcom NetXtreme

Gigabit Ethernet Plus NIC USB Cable Assembly, CD, drivers, quick install

guide, product warranty statement

Technical Specifications - Networking and Communications

Intel Gigabit CT Desktop Connector

NIC

Connector RJ-45

Controller Intel WG82574L Gigabit Ethernet Controller

Memory Integrated Dual 48K configurable transmit receive FIFO Buffers

Data Rates Supported 10/100/1000 Mbps

Compliance IEEE 802.1P, 802.1Q, 802.2, 802.3, 802.3AB and 802.3u compliant,

802.3x flow control

Bus Architecture PCI-E 1.0a

Data Path Width X1, 250 MB/s, Bi-directional interface

Data Transfer Mode Bus-master DMA

Hardware Certifications FCC, B, CE, TUV- cTUVus Mark Canada and United States, TUV- GS Mark

for European Union

Power Requirement Aux 3.3V, 3.0 Watts in 1000base-T and 2.0 Watts in 100Base-T

Boot ROM Support Yes

Network Transfer Rate 10BASE-T (half-duplex) 10 Mbps

10BASE-T (full-duplex) 20 Mbps 100BASE-TX (half-duplex) 100 Mbps 100BASE-TX (full-duplex) 200 Mbps 1000BASE-T (full-duplex) 2000 Mbps

Operating Temperature 32° to 131°F (0° to 55° C)
Operating Humidity 85% at 131° F (55° C)

Dimensions 4.75 x 2.25 x 0.8 in (12.1 x 5.7 x 2.0 cm)

Operating System Driver

Support

Windows Vista Business 64, Windows Vista Business 32, Windows XP

Professional, Windows XP x64.

Red Hat Enterprise Linux 4, Red Hat Enterprise Linux 5.

Management Capabilities WOL , PXE, DMI, WFM 2.0

Kit Contents Intel Gigabit CT Desktop NIC, low profile bracket, CD containing Intel

PROset II NIC drivers, quick install guide, product warranty statement

© Copyright 2009 Hewlett-Packard Development Company, L.P.

The information contained herein is subject to change without notice.

All rights reserved. Microsoft, Windows, Windows Vista, and Windows XP are registered trademarks or trademarks of Microsoft Corporation in the U.S. and/or other countries. Intel, the Intel logo, Pentium, and Pentium Inside are trademarks or registered trademarks of Intel Corporation or its subsidiaries in the United States and other countries. Linux is a registered trademark of Linus Torvalds in the United States and other countries.

Warranty - year(s) Protected by HP Services, including a 3 years parts, 3 years labor, and 3 years onsite service (3/3/3) standard warranty. Terms and conditions vary by country. Certain restrictions and exclusions apply.

